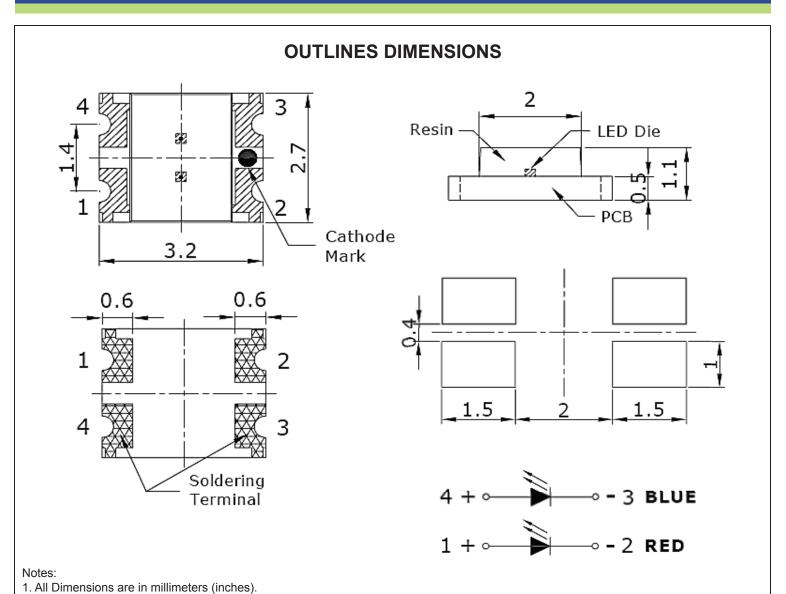


2. Tolerance is \pm 0.25mm (0.01") unless otherwise noted. 3. Specifications are subject to change without notice.

SPECIFICATIONS CS121R2B2C



Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle
CS121R2B2C	InGaAlP/InGaN	Red/Blue	Water Clear	120°





ABSOLUTE MAXIMUM RATINGS

(TA=25°C)

Parameter	Symbol	Color	Max Rating	Unit	
Power Discipation	PD	RED	60	mW	
Power Dissipation		BLUE	95		
Pulse Current Forward Current	lfP	RED	100	mA	
Fulse Current Forward Current		BLUE	100	IIIA	
Continuous Forward Current	lF	RED	25	m Λ	
Continuous Forward Current		BLUE	25	mA	
Reverse Voltage	VR	5		V	
Operating Temperature Range	Topr	-40~+80		°C	
Storage Temperature Range	Тѕтс	-40~+85		°C	
IFP = Pulse Width ≤ 10 ms, Duty Ratio ≤1/10. Soldering Condition: 260 °C/ 5sec					

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

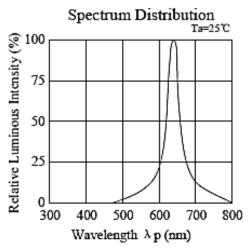
Doromotor	Symbol	Test Condi- tion	Color	Value			Lloit
Parameter				Min	Тур	Max	Unit
Luminous Intensity	lv.	I _F = 20mA	Red	80	150	-	mod
Luminous intensity	Iv	IF = 20MA 	Blue	60	120	-	mcd
Forward Voltage	VF	I _F = 20mA	RED	1.6	2.0	2.4	V
Forward Voltage			Blue	2.8	3.4	3.8	
Poverse Leakage Current	lR	V _R = 5V	RED	ı	-	10	μΑ
Reverse Leakage Current			Blue	-	-	10	
Viewing Angle	201/2	I _F = 20mA	RED	ı	120	-	deg
Viewing Angle			Blue	-	120	-	
Dominant Wavelength	λD	I _F = 20mA	RED	-	624	-	nm
Dominant wavelength	ΛD	I	Blue	-	470	-	nm

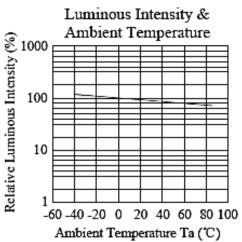
^{*}Tolerance of viewing angle: -10 / +5 deg.

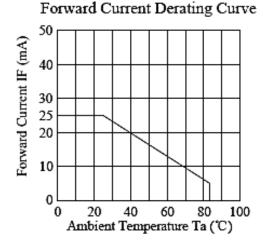


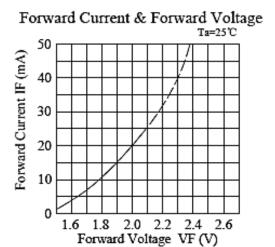


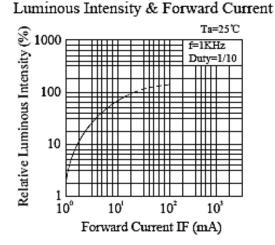
OPTICAL CHARACTERISTIC CURVES (RED)

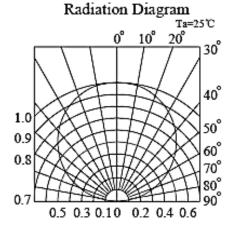








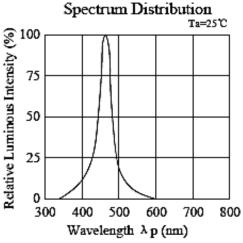


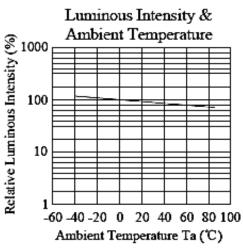


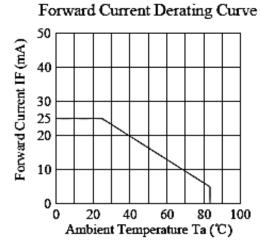


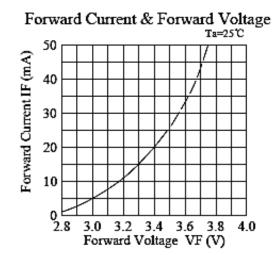


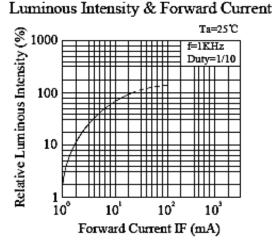
OPTICAL CHARACTERISTIC CURVES (GREEN)

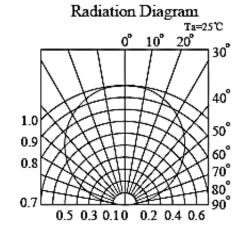
















SOLDERING CONDITIONS – LAMP TYPE LED

PRECAUTION FOR USE

1. Over-Current-Proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change & burn out will happen.

2. Storage

- 2.1 Do not open moisture proofs bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30 °C or less and 80% RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30 °C or less and 60% RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material has faded away or the LEDs have exceed the storage time, baking treatment should be performed using the following conditions: 60±5 °C for 24 hours.

3. Soldering condition

When soldering lamps without stopper style, it is recommended to leave a minimum of 3mm clearance from the base of the lens to the soldering joint.

To avoid the epoxy climb up to lead frame and impact the non-soldering pattern, dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

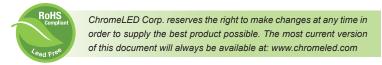
Recommended soldering conditions:

Soldering Iron		Wave Soldering		
Temperature	300℃ Max.	Pre-heat	100℃ Max.	
Soldering Time	3 sec. Max.	Pre-heat Time	60 sec. Max.	
	(one time only)	Solder Wave	260°C Max.	
		Soldering Time	5 sec. Max.	

Note: excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED.

4. Soldering Iron

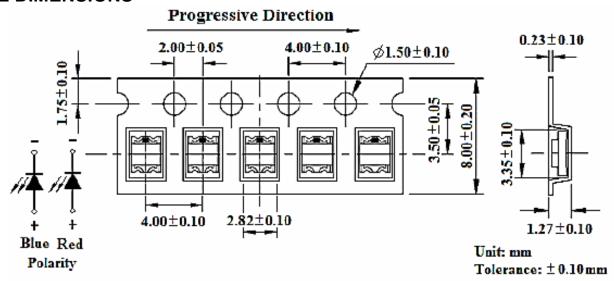
Each terminal is to go to the tip of the soldering iron temperature less than 260 °C for 5 seconds within one time in less than the soldering iron capacity of 25W. Leave two seconds and more intervals and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.



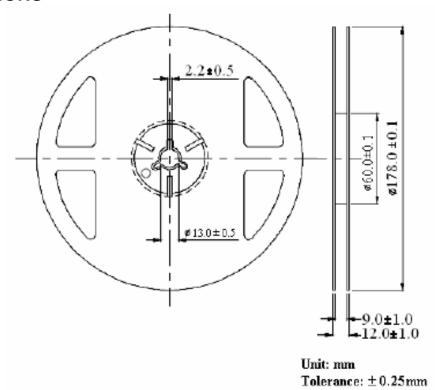


PACKAGING SPECIFICATIONS

TAPE DIMENSIONS



REEL DIMENSIONS



*Loaded quantity: 3000 pcs per reel.

